

# R6030ENZ Nch 600V 30A Power MOSFET

V <sub>DSS</sub>	600V
R <sub>DS(on)</sub> (Max.)	0.130Ω
I <sub>D</sub>	30A
P <sub>D</sub>	120W

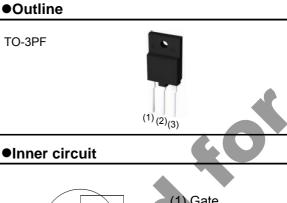
## Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V<sub>GSS</sub>) guaranteed to be  $\pm 20$ V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.

Switching Power Supply

Application

6) Pb-free lead plating ; RoHS compliant





# Packaging specifications

(1)

	Packaging	Tube
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Quantity (pcs)	360
	Taping code	C8
	Marking	R6030ENZ
c)		

# •Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	600	V
Continuous drain current $T_c = 25^{\circ}C$	ا <sub>D</sub> *1	±30	А
$T_c = 100^{\circ}C$	ا <sub>D</sub> *1	±16.3	А
Pulsed drain current	I <sub>D,pulse</sub> *2	±80	А
Gate - Source voltage	V <sub>GSS</sub>	±20	V
Avalanche energy, single pulse	E <sub>AS</sub> <sup>*3</sup>	636	mJ
Avalanche energy, repetitive	E <sub>AR</sub> <sup>*3</sup>	0.96	mJ
Avalanche current, repetitive	I <sub>AR</sub>	5.2	А
Power dissipation ( $T_c = 25^{\circ}C$ )	P <sub>D</sub>	120	W
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C
Reverse diode dv/dt	dv/dt *4	15	V/ns

# •Absolute maximum ratings

Parameter	Symbol	Conditions	Values	Unit
Drain - Source voltage slope	dv/dt	V <sub>DS</sub> = 480V T <sub>j</sub> = 25°C	50	V/ns

### Thermal resistance

Parameter	Symbol		Values		Unit		
Faranielei	Symbol	Min.	Тур.	Max.	Unit		
Thermal resistance, junction - case	R <sub>thJC</sub>	- (		1.04	°C/W		
Thermal resistance, junction - ambient	R <sub>thJA</sub>		-	40	°C/W		
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>		-	265	°C		
•Electrical characteristics ( $T_a = 25^{\circ}C$ )							
			Values				

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Faranielei	Symbol	Cunditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA	600	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	-	0.1	100 1000	μΑ
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	-	-	±100	nA
Gate threshold voltage	V <sub>GS (th)</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	2	-	4	V
Static drain - source on - state resistance	R <sub>DS(on)</sub> *5	$V_{GS}$ = 10V, $I_{D}$ = 14.5A T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	-	0.115 0.255	0.130	Ω
Gate input resistance	R <sub>G</sub>	f = 1MHz, open drain	-	3.6	-	Ω

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Cumbal	Conditions	Values			L locit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Transconductance	${\sf g}_{\sf fs}$ *5	V <sub>DS</sub> = 10V, I <sub>D</sub> = 15A	8	16	-	S
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	2100	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	1900		pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	190		
Effective output capacitance, energy related	C <sub>o(er)</sub>	V <sub>GS</sub> = 0V	-	82	-	~ <b>F</b>
Effective output capacitance, time related	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0V to 480V	0	400	-	pF
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DD} \simeq 300 V, V_{GS}$ = 10V	<u> </u>	40	-	
Rise time	t <sub>r</sub> *5	I <sub>D</sub> = 15A	-	55	-	20
Turn - off delay time	t <sub>d(off)</sub> *5	R <sub>L</sub> = 20Ω		190	-	ns
Fall time	t <sub>f</sub> *5	R <sub>G</sub> <del>π</del> 10Ω		60	-	

# ●Gate Charge characteristics (T<sub>a</sub> = 25°C

Parameter	Symbol Conditions -		Values			Unit
Farameter			Min.	Тур.	Max.	Onit
Total gate charge	$Q_g^{*5}$	$V_{DD} \simeq 300V$	-	85	-	
Gate - Source charge	Q <sub>gs</sub> *5	I <sub>D</sub> = 30A	-	15	-	nC
Gate - Drain charge	Q <sub>gd</sub> *5	V <sub>GS</sub> = 10V	-	45	-	
Gate plateau voltage	V <sub>(plateau)</sub>	$V_{DD} \simeq 300V, I_D = 30A$	-	6.5	-	V

\*1 Limited only by maximum temperature allowed.

\*2  $P_W \le 10\mu s$ , Duty cycle  $\le 1\%$ 

\*3  $I_D$  = 5.2A,  $V_{DD}$  = 50V

\*4 Reference measurement circuits Fig.5-1.

\*5 Pulsed

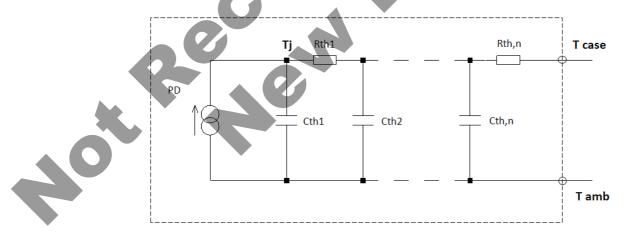
# **R6030ENZ**

# ●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inverse diode continuous, forward current	ا <sub>S</sub> *1	T <sub>c</sub> = 25°C	-	-	30	А
Inverse diode direct current, pulsed	I <sub>SM</sub> *2	T <sub>c</sub> = 23 C	-	-	80	A
Forward voltage	$V_{SD}$ *5	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-	-	1.5	V
Reverse recovery time	t <sub>rr</sub> *5		- (	660	-	ns
Reverse recovery charge	Q <sub>rr</sub> <sup>*5</sup>	I <sub>S</sub> = 30A di/dt = 100A/μs	- 7	15	-	μC
Peak reverse recovery current	<sup>*5</sup>		T	45	-	А

# •Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	0.0865		C <sub>th1</sub>	0.00598	
R <sub>th2</sub>	0.469	K/W	C <sub>th2</sub>	0.0547	Ws/K
R <sub>th3</sub>	1.22		C <sub>th3</sub>	1.09	





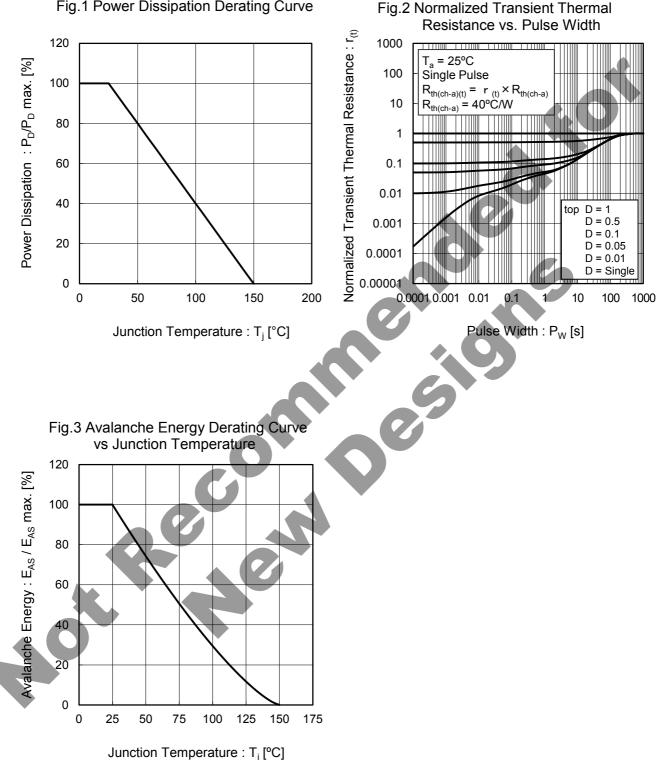


Fig.1 Power Dissipation Derating Curve

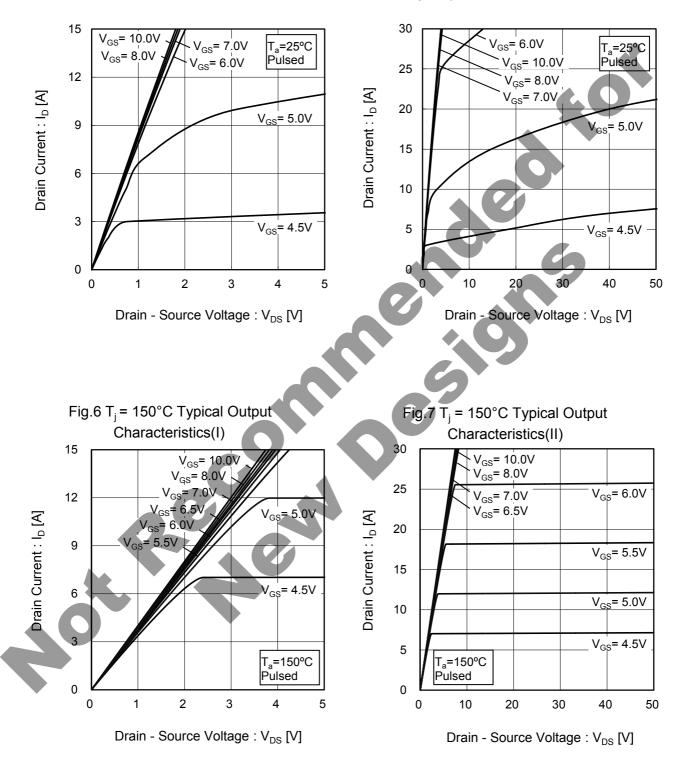
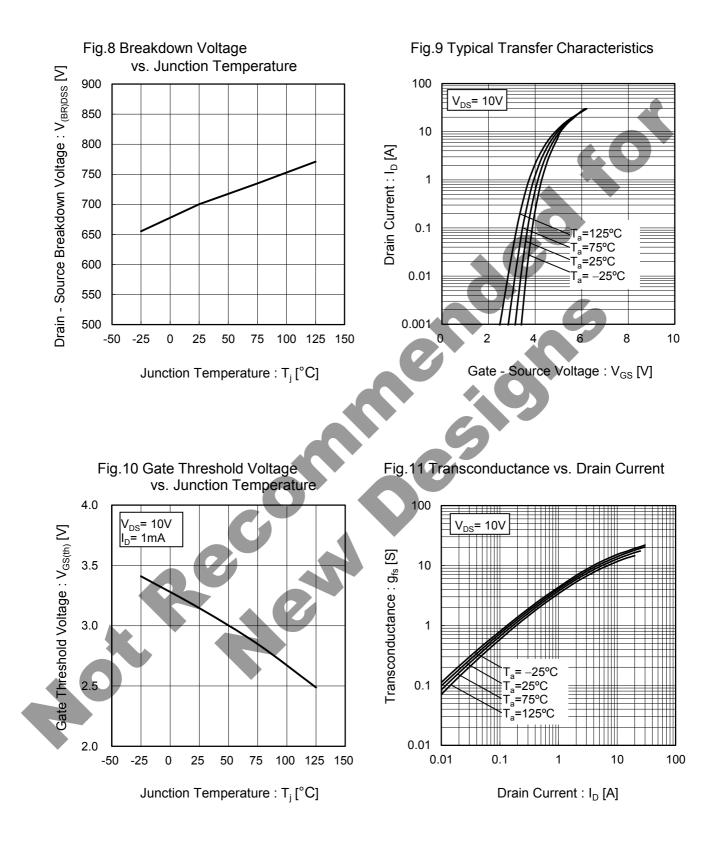
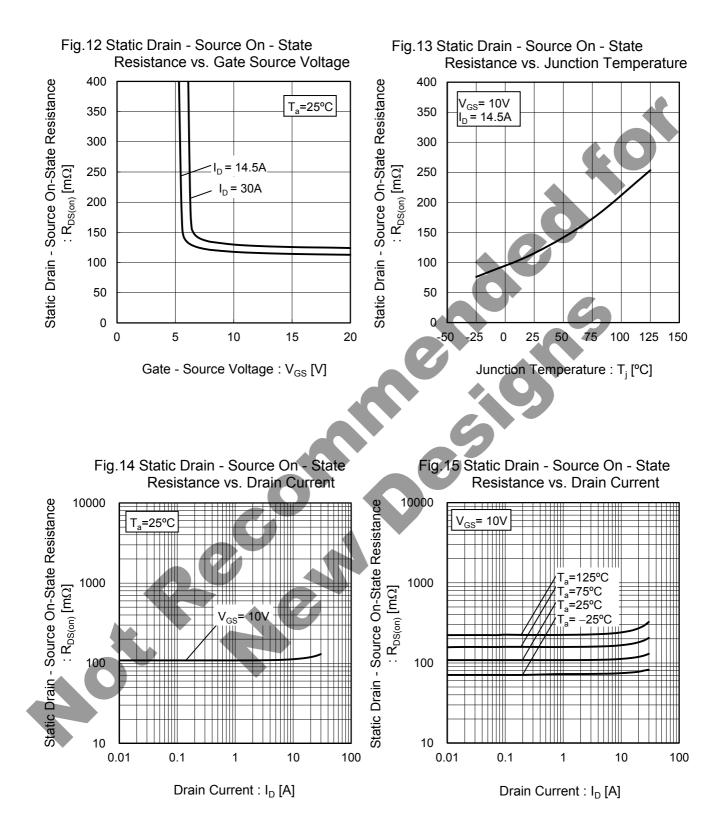
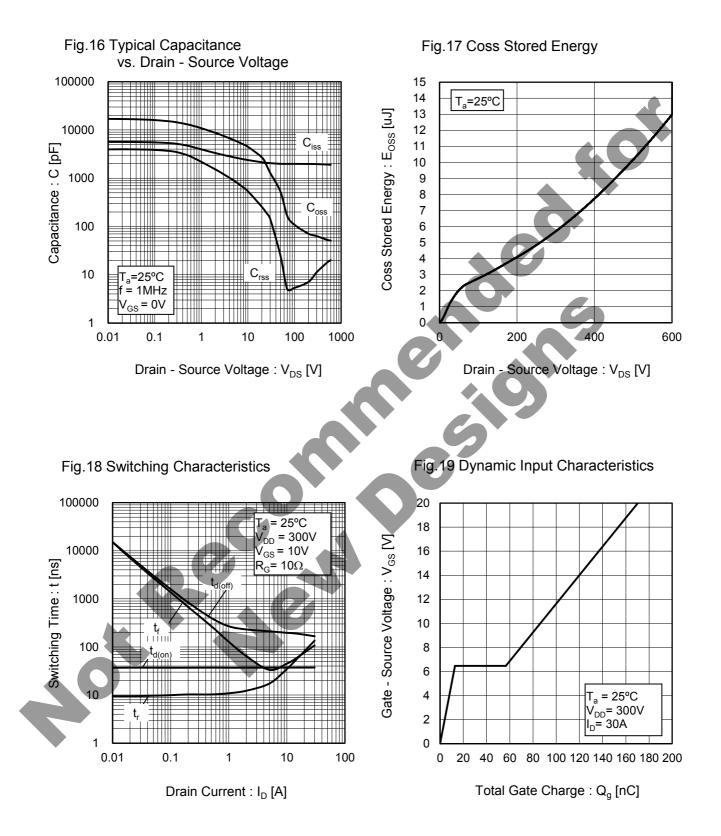


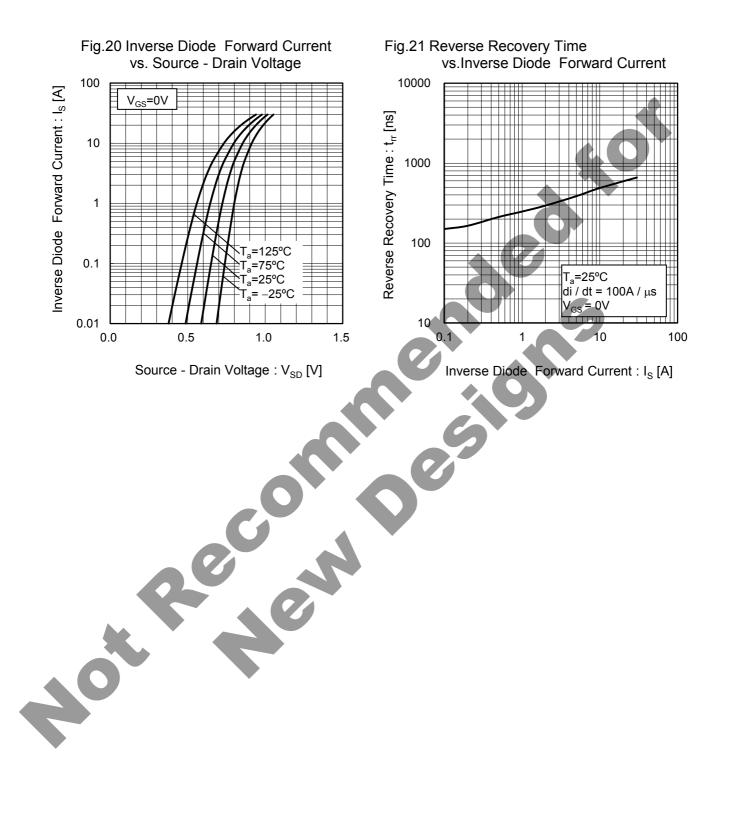
Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)



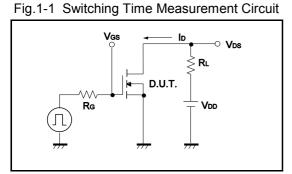








## •Measurement circuits





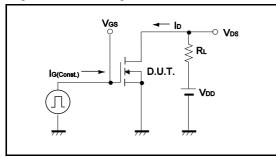
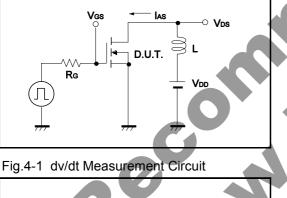


Fig.3-1 Avalanche Measurement Circuit



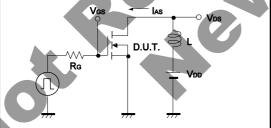


Fig.5-1 di/dt Measurement Circuit

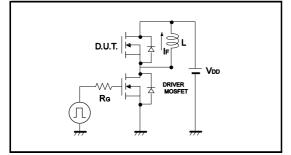


Fig.1-2 Switching Waveforms

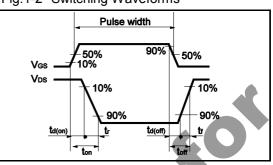


Fig.2-2 Gate Charge Waveform

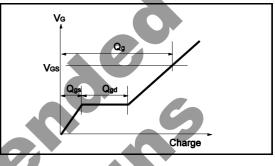


Fig.3-2 Avalanche Waveform

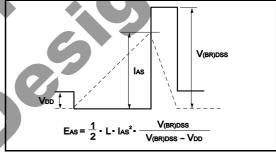


Fig.4-2 dv/dt Waveform

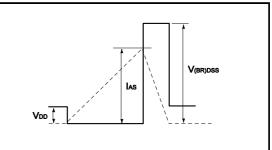
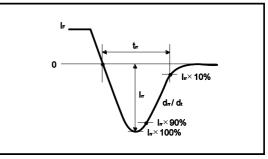
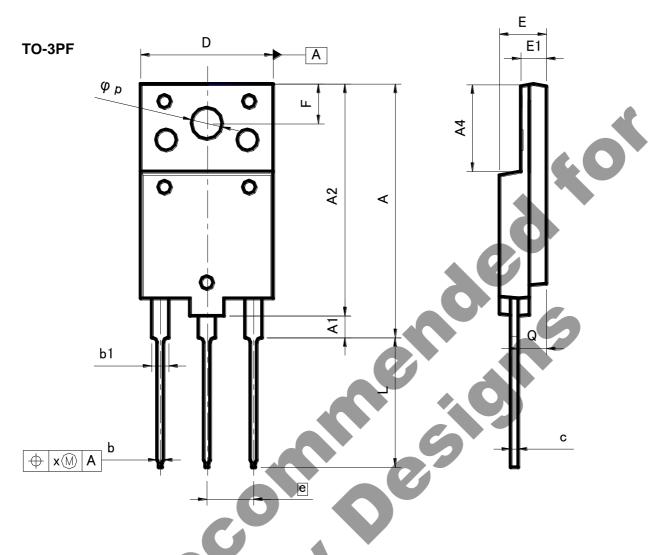
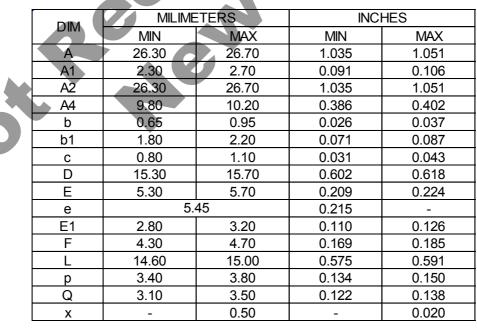


Fig.5-2 di/dt Waveform



#### •Dimensions (Unit : mm)





Dimension in mm / inches

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(Note1) Medical Equipment Classification of the Specific Applications						
	JAPAN	USA	EU	CHINA		

JAPAN	USA	EU	CHINA	
CLASSⅢ		CLASS II b		
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSI	

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

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